

## PATENT ABSTRACTS OF JAPAN

(11)Publication number : 08-207408

(43)Date of publication of application : 13.08.1996

(51)Int.Cl.

B41K 1/32

B41L 13/02

(21)Application number : 07-301214

(71)Applicant : BROTHER IND LTD

(22)Date of filing : 20.11.1995

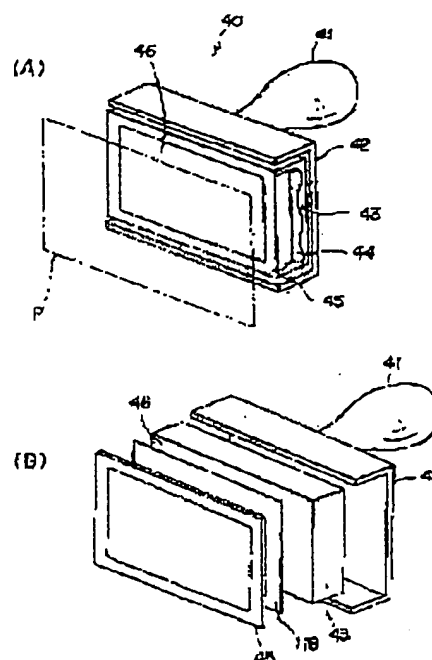
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## (54) STAMP DEVICE

## (57)Abstract:

PURPOSE: To obtain a simple stamp device using heat-sensitive stencil base paper.

CONSTITUTION: On one surface of a frame body 43 incorporating an ink pad, heat-sensitive stencil base paper 118 with a perforated image is detachably mounted. The other surface of the frame body 43 is inserted into an outer frame 42 having a U-shaped cross section. A grip 41 is fixed on the back surface of the outer frame 42 in the center thereof.



## LEGAL STATUS

[Date of request for examination] 11.09.1997

[Date of sending the examiner's decision of rejection] 21.12.1999

[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]

[Date of final disposal for application]

[Patent number]

[Date of registration]

[Number of appeal against examiner's decision of rejection]

[Date of requesting appeal against examiner's decision of rejection]

[Date of extinction of right]